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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# **HD74LS257**

# Quadruple 2-line-to-1-line Data Selectors / Multiplexers (with not inverted 3-state outputs)

REJ03D0469-0300 Rev.3.00 Jul.15.2005

This multiplexer features three-state outputs that can interface directly with and drive data lines of bus-organized systems. With all but one of the common outputs disabled (at a high-impedance state) the low impedance of the single enabled output will drive the bus line to a high or low logic level.

To minimize the possibility that two outputs will attempt to take a common bus to opposite logic levels, the outputenable circuitry is designed such that the output disable times are shorter than the output enable times.

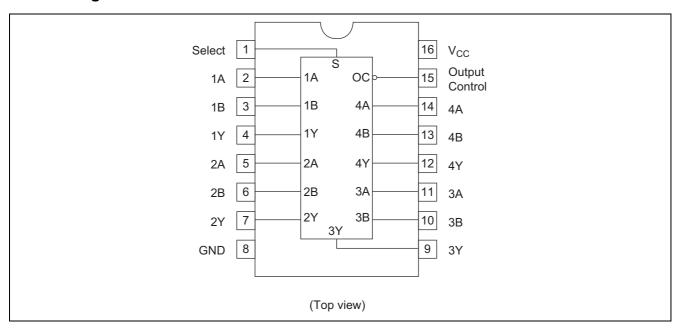
#### **Features**

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS257P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	Р	_
HD74LS257FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

#### **Pin Arrangement**

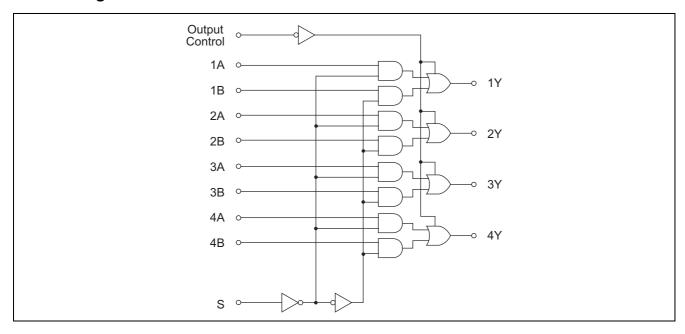


#### **Function Table**

	Output			
OC	S	Α	В	Output
Н	Х	X	X	Z
L	L	L	X	L
L	L	Н	X	Н
L	Н	X	L	L
L	Н	X	Н	Н

Note: H; high level, L; low level, X; irrelevant, Z; off (high-impedance) state of a 3-state output

## **Block Diagram**



## **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit
Supply voltage	V <sub>CC</sub>	7	V
Input voltage	V <sub>IN</sub>	7	V
Output voltage (off-state)	V <sub>O (off)</sub>	5.5	V
Operating temperature	Topr	-20 to +75	°C
Power dissipation	P <sub>T</sub>	400	mW
Storage temperature	Tstg	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

## **Recommended Operating Conditions**

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	Vcc	4.75	5.00	5.25	V
Output current	I <sub>OH</sub>	_	_	-2.6	mA
Output current	I <sub>OL</sub>	_	_	8	mA
Operating temperature	Topr	-20	25	75	°C

### **Electrical Characteristics**

 $(Ta = -20 \text{ to } +75 \text{ }^{\circ}\text{C})$ 

Item		Symbol	min.	typ.*	max.	Unit	Condition	
Input voltage		V <sub>IH</sub>	2.0	_	_	V		
		V <sub>IL</sub>	_	_	0.8	V		
		V <sub>OH</sub>	2.4	_	_	V	$V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V}, V_{IL} = 0.8 \text{ V},$ $I_{OH} = -2.6 \text{ mA}$	
Output vol	tage	V <sub>OL</sub>	_	_	0.5	V	$I_{OL} = 8 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, V_{IH} = 2 \text{ V},$	
			_	_	0.4	V	$I_{OL} = 4 \text{ mA}$ $V_{IL} = 0.8 \text{ V}$	
S		1	_	_	40		$V_{CC} = 5.25 \text{ V}, V_{I} = 2.7 \text{ V}$	
	S except	I <sub>IH</sub>	_	_	20	μΑ	VCC = 5.25 V, V  = 2.7 V	
Input	S	I <sub>IL</sub>	_	_	-0.8	mA	$V_{CC} = 5.25 \text{ V}, V_1 = 0.4 \text{ V}$	
current	S except		_	_	-0.4	IIIA		
	S		_	_	0.2	mA	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = 7 V	
	S except	l <sub>l</sub>	_	_	0.1	IIIA		
Output our	ront	l <sub>OZ</sub>	_	_	20	^	V <sub>0</sub> = 2.4 V	
Output cui	Output current				-20	μΑ	$V_0 = 2.4 \text{ V}$ $V_0 = 0.4 \text{ V}$ $V_{CC} = 5.25 \text{ V}, V_{IH} = 2 \text{ V}$	
Short-circuit output current		los	-30	_	-130	mA	V <sub>CC</sub> = 5.25 V	
Cupply	All outputs high		_	5.9	10			
Supply current**	All outputs low	Icc	_	9.2	16	mA	V <sub>CC</sub> = 5.25 V	
	All outputs off		_	10	19			
Input clamp voltage		V <sub>IK</sub>	_	_	-1.5	V	$V_{CC} = 4.75 \text{ V}, I_{IN} = -18 \text{ mA}$	

Notes:  $^*V_{CC} = 5 \text{ V}$ ,  $Ta = 25^{\circ}C$ 

## **Switching Characteristics**

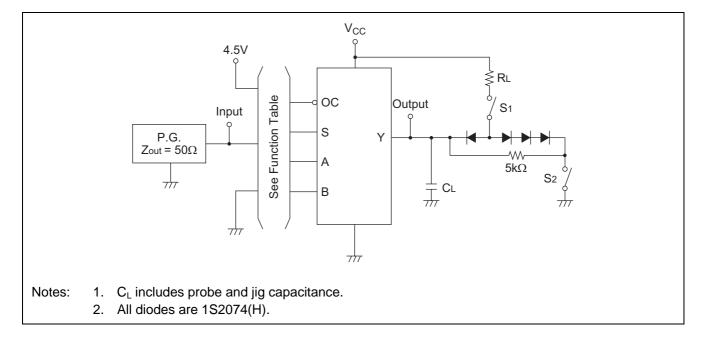
 $(V_{CC} = 5 \text{ V}, \text{Ta} = 25^{\circ}\text{C})$ 

Item	Symbol	Inputs	Output	min.	typ.	max.	Unit	Condition
Propagation delay time	t <sub>PLH</sub>	A, B	V	_	12	18	ne	
	t <sub>PHL</sub>	А, Б	ī	_	12	18	ns	$C_L = 15 \text{ pF},$ $R_L = 2 \text{ k}\Omega$
	t <sub>PLH</sub>	S	Υ	_	14	21	ns	
	t <sub>PHL</sub>			_	14	21		$R_L = 2 k\Omega$
Output enable time	t <sub>ZH</sub>	ОС	V	_	20	30	no	]
	t <sub>ZL</sub>		ī	_	20	30	ns	
Output disable time	t <sub>HZ</sub>	ОС	V	_	18	30	ne	$C_L = 5 \text{ pF},$ $R_L = 2 \text{ k}\Omega$
	t <sub>LZ</sub>		ľ	_	16	25	ns	$R_L = 2 k\Omega$

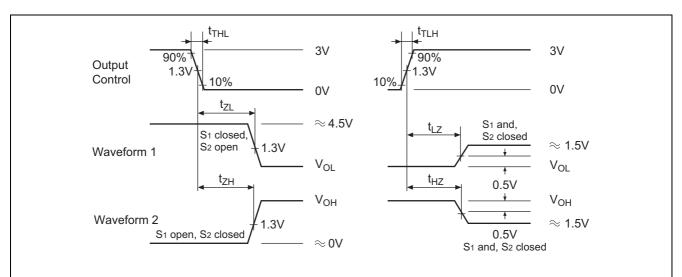
<sup>\*\*</sup> I<sub>CC</sub> is measured with all outputs open and all possible inputs grounded while achieving the stated output conditions.

### **Testing Method**

#### **Test Circuit**



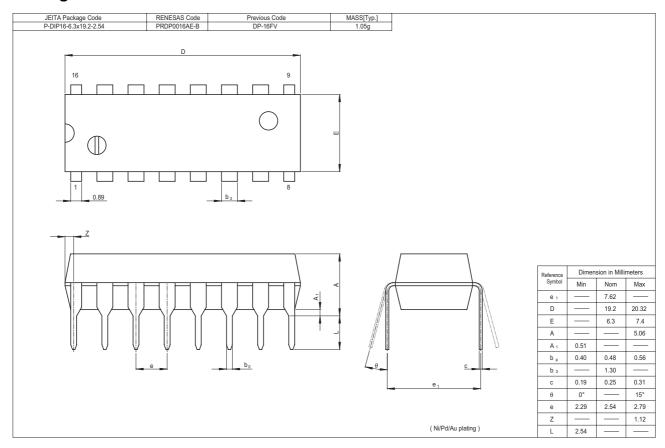
#### Waveform

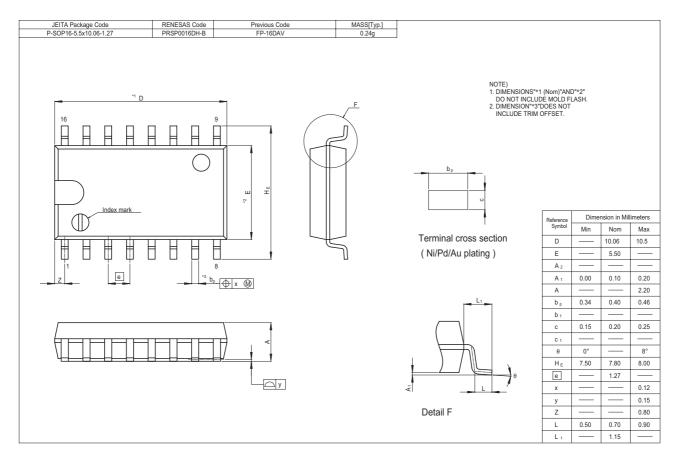


Notes:

- 1. Input pulse;  $t_{TLH} \le 15$  ns,  $t_{THL} \le 6$  ns, PRR = 1 MHz, duty cycle = 50%
- 2. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
- 3. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

### **Package Dimensions**





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